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PTO-1595 F) CHEET HE DEPARTMENT OF SOME	
То	the Honorable Commissioner of Patents and 10209343	9	attached original documents or copy thereof.	
	Name of conveying party(ies):	2	Name and address of receiving party(ies):	
	Nai-Cheng Lu $5-9-2$ Yu-Ting Liao Fu-Sung Liu		Taiwan Semiconductor Manufacturing Co. Ltd. No. 121 Park Avenue 3 Science-Based Industrial Park Hsin-Chu, Taiwan, R.O.C.	
3	Nature of conveyance: ■ Assignment		Additional name(s) & address(es) attached □ Yes	
l	☐ Security Agreement ☐ Change of Name			
	Other: Execution Date: Feb, 4, 2002			
4	Application number(s) or patent number(s):			
	If this document is being filed together with a new application	, the	execution date of the application is: 02-04-02	
	A. Patent Application No(s).		B. Patent No(s)	
Additional numbers attached? □ Yes ⊠ No				
5	Name and address of party to whom correspondence concerning document should be mailed:	6	Total number of applications and patents involved:	
	RANDY W. TUNG Tung & Associates	7	Total fee (37 CFR 3.41) \$40.00	
	838 W. Long Lake Road Suite 120		□ Enclosed	
	Bloomfield Hills, Michigan 48302			
2002	2 AMABI1 00000011 10143412	8	Deposit Account Number: 50-0484	
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9	Statement and signature.			
	To the best of my knowledge and belief the foregoing information the original document.	ation	n is true and correct and any attached copy is a true copy of	
	Randy W. Tung Name of Person Signing Signature		May 9, 2002 Date	
	Registration No. 31,311			
	Total number of pages including cover sheet, attachments, and document : 3			
	Mail documents to be recorded with required cover sheet information to. Commissioner of Patents & Trademarks, Box Assignments			

Washington, D.C. 20231

ASSIGNMENT

WHEREAS, we, <u>NAI-CHENG LU, YU-TING LIAO and FU-SUNG LIU</u>, have invented certain improvements in

METHOD FOR FABRICATING MICROELECTRONIC FABRICATION

ELECTRICAL TEST APPARATUS ELECTRICAL PROBE TIP

for which we are about to make application for Letters Patent of the United States; and

WHEREAS, TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD. of No. 121, Park Avenue 3, Science-Based Industrial Park, Hsin-Chu, Taiwan, R.O.C, is desirous of acquiring the entire right, title and interest in and to said invention;

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PATENT REEL: 012892 FRAME: 0476

or continuation-in-part application thereof, and in and to any reissue of any such patent, and in and to any patent applications which may be filed on said invention in countries foreign to the United States and any Letters Patent granted thereon.

We further authorize said corporation to apply for foreign patents on said invention in its own name or through its designees, including subsidiaries, related companies or assignees, under the International Convention or otherwise, and we further agree to execute all papers, including those required for the United States and foreign applications, and to perform such other proper acts as said corporation or its designees the rights herein assigned.

The Lind Line

Nai-Cheng Lu NAI-CHENGTU

Fu-sung Liu

TUNG & ASSOCIATES 838 W. Long Lake Road Suite 120 Bloomfield Hills, Michigan 48302

RECORDED: 05/09/2002

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